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Team Nexperia



BC847BPN

45 V, 100 mA NPN/PNP general-purpose transistor

Rev. 04 — 18 February 2009

Product data sheet

1. Product profile

1.1 General description

NPN/PNP general-purpose transistor pair in a very small SOT363 (SC-88) Surface-Mounted Device (SMD) plastic package.

1.2 Features

- Low collector capacitance
- Low collector-emitter saturation voltage
- Closely matched current gain
- Reduces number of components and board space
- No mutual interference between the transistors

1.3 Applications

■ General-purpose switching and amplification

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor; for the PNP transis	tor with negative polarity	1			
V_{CEO}	collector-emitter voltage	open base	-	-	45	V
Ic	collector current		-	-	100	mA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$	200	-	450	

2. Pinning information

Table 2. Pinning

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1	G. G. G.	
2	base TR1	6 5 4	6 5 4
3	collector TR2		TR2
4	emitter TR2	0	(TR1)
5	base TR2	□1 □2 □3	
6	collector TR1		1 2 3
			sym019



45 V, 100 mA NPN/PNP general-purpose transistor

3. Ordering information

Table 3. Ordering information

Type number	Package			
	Name	Description	Version	
BC847BPN	SC-88	plastic surface-mounted package; 6 leads	SOT363	

4. Marking

Table 4. Marking codes

Type number	Marking code ^[1]
BC847BPN	13*

^{[1] * = -:} made in Hong Kong

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per transistor; for the PNP transistor with negative polarity					
V_{CBO}	collector-base voltage	open emitter	-	50	V
V_{CEO}	collector-emitter voltage	open base	-	45	V
V_{EBO}	emitter-base voltage	open collector	-	5	V
I _C	collector current		-	100	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	200	mA
I _{BM}	peak base current	single pulse; $t_p \le 1 \text{ ms}$	-	200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	<u>[1]</u> _	220	mW
			[2] _	250	mW
Per device	•				
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	<u>[1]</u> _	300	mW
			[2] _	400	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

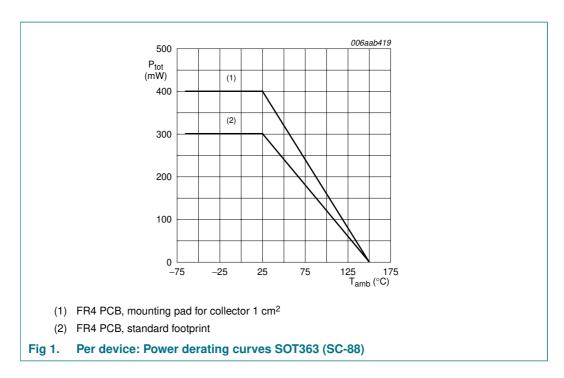
^{* =} p: made in Hong Kong

^{* =} t: made in Malaysia

^{* =} W: made in China

^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

45 V, 100 mA NPN/PNP general-purpose transistor



6. Thermal characteristics

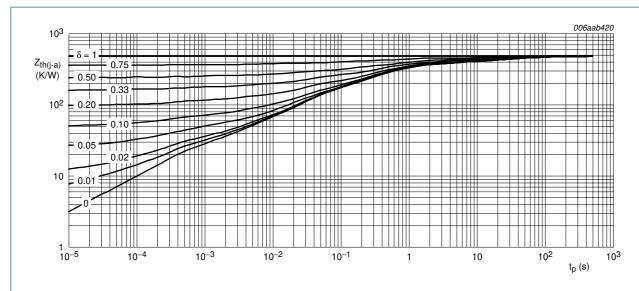
Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transist	or					
uit (j a)	thermal resistance from junction to ambient		[1] _	-	568	K/W
			[2] _	-	500	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	230	K/W
Per device						
R _{th(j-a)}	thermal resistance from	in free air	[1] -	-	416	K/W
	junction to ambient		[2] _	-	313	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

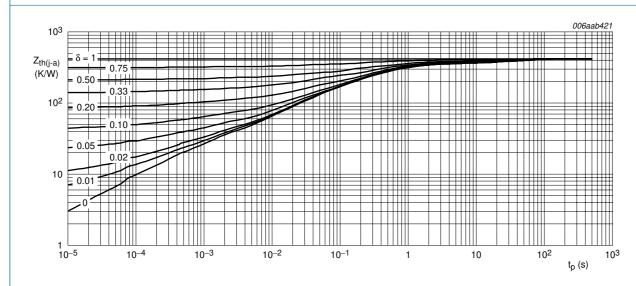
^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

45 V, 100 mA NPN/PNP general-purpose transistor



FR4 PCB, standard footprint

Fig 2. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for collector 1 cm²

Fig 3. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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45 V, 100 mA NPN/PNP general-purpose transistor

7. Characteristics

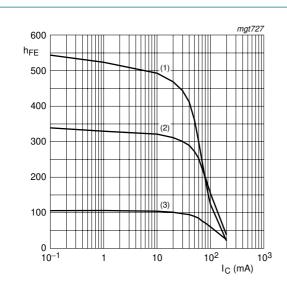
Table 7. Characteristics

T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	Per transistor; for the PNP transistor with negative polarity					
I _{CBO}	collector-base cut-off	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$	-	-	15	nA
	current	$V_{CB} = 30 \text{ V; } I_E = 0 \text{ A;}$ $T_j = 150 ^{\circ}\text{C}$	-	-	5	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$	-	-	100	nA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$	200	-	450	
V _{CEsat}	collector-emitter	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	-	-	100	mV
	saturation voltage	I _C = 100 mA; I _B = 5 mA	[1] -	-	300	mV
V _{BEsat}	base-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	-	755	-	mV
V_{BE}	base-emitter voltage	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$				
	TR1 (NPN)		580	655	700	mV
	TR2 (PNP)		600	655	750	mV
C _c	collector capacitance	$I_E = i_e = 0 A; V_{CB} = 10 V;$ f = 1 MHz				
	TR1 (NPN)		-	-	1.5	рF
	TR2 (PNP)		-	-	2.2	рF
C _e	emitter capacitance	$I_C = I_c = 0 A; V_{EB} = 0.5 V;$ f = 1 MHz				
	TR1 (NPN)		-	11	-	pF
	TR2 (PNP)		-	10	-	pF
f _T	transition frequency	$I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V};$ f = 100 MHz	100	-	-	MHz

^[1] Pulse test: $t_p \leq 300~\mu s; \, \delta \leq 0.02.$

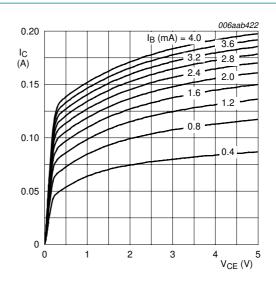
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$$V_{CE} = 5 V$$

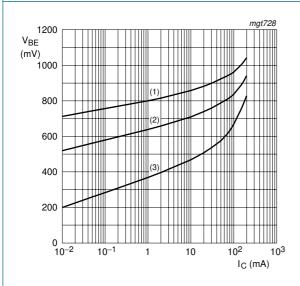
- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \,^{\circ}C$

Fig 4. TR1 (NPN): DC current gain as a function of collector current; typical values



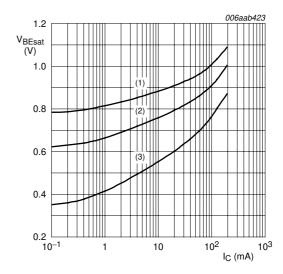
 $T_{amb} = 25 \, ^{\circ}C$

Fig 5. TR1 (NPN): Collector current as a function of collector-emitter voltage; typical values



- $V_{CE} = 5 V$
- (1) $T_{amb} = -55 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

Fig 6. TR1 (NPN): Base-emitter voltage as a function of collector current; typical values



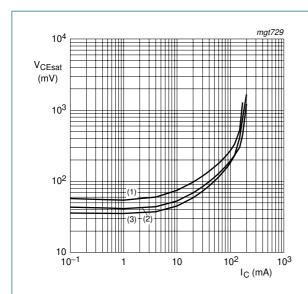
 $I_{\rm C}/I_{\rm B} = 20$

- (1) $T_{amb} = -55 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

Fig 7. TR1 (NPN): Base-emitter saturation voltage as a function of collector current; typical values

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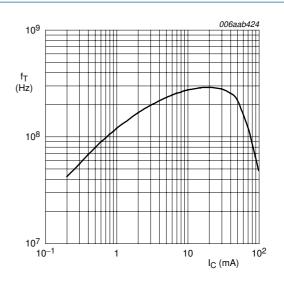
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$$I_{\rm C}/I_{\rm B} = 20$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \,^{\circ}C$

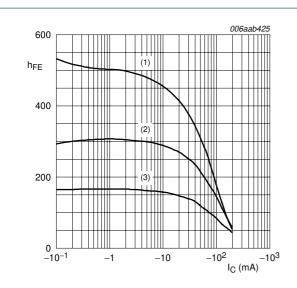
Fig 8. TR1 (NPN): Collector-emitter saturation voltage as a function of collector current; typical values



 V_{CE} = 5 V; f = 1 MHz; T_{amb} = 25 °C

Fig 9. TR1 (NPN): Transition frequency as a function of collector current; typical values

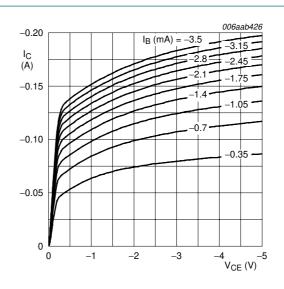
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$$V_{CE} = -5 \text{ V}$$

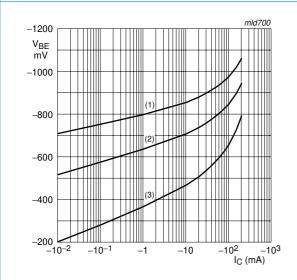
- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 10. TR2 (PNP): DC current gain as a function of collector current; typical values



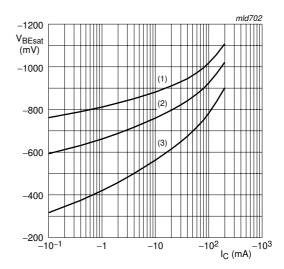
 $T_{amb} = 25 \, ^{\circ}C$

Fig 11. TR2 (PNP): Collector current as a function of collector-emitter voltage; typical values



- $V_{CE} = -5 \text{ V}$
- (1) $T_{amb} = -55 \,^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

Fig 12. TR2 (PNP): Base-emitter voltage as a function of collector current; typical values



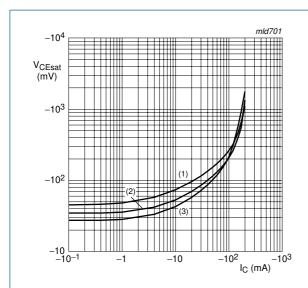
 $I_{C}/I_{B} = 20$

- (1) $T_{amb} = -55 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

Fig 13. TR2 (PNP): Base-emitter saturation voltage as a function of collector current; typical values

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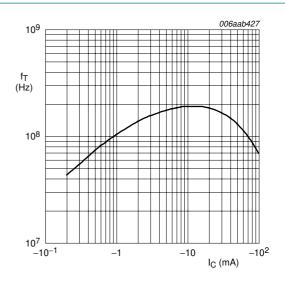
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$$I_C/I_B = 20$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 14. TR2 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values

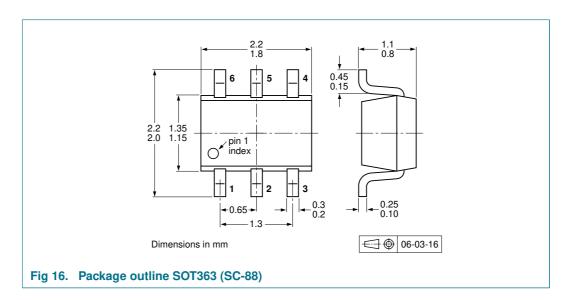


$$V_{CE} = -5 \text{ V}; f = 1 \text{ MHz}; T_{amb} = 25 \,^{\circ}\text{C}$$

Fig 15. TR2 (PNP): Transition frequency as a function of collector current; typical values

45 V, 100 mA NPN/PNP general-purpose transistor

8. Package outline



9. Packing information

Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description		Packing quantity	
				3000	10000
BC847BPN	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-165

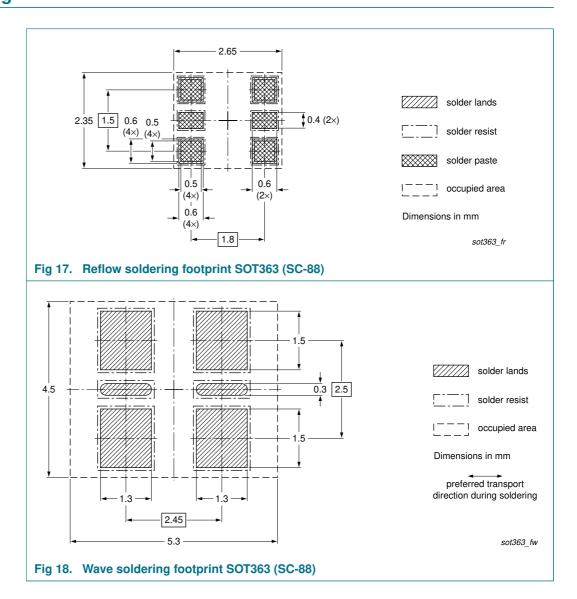
^[1] For further information and the availability of packing methods, see Section 13.

[2] T1: normal taping

[3] T2: reverse taping

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10. Soldering



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11. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
BC847BPN_4	20090218	Product data sheet	-	BC847BPN_3		
Modifications:	 The format o of NXP Semi 		edesigned to comply wi	th the new identity guidelines		
	 Legal texts h 	ave been adapted to the ne	ew company name whe	re appropriate.		
	 Section 4 "M 	arking": updated				
	Section 7 "Characteristics": enhanced					
	 Section 9 "Page 1 	acking information": added				
	Section 10 "S	Soldering": added				
	 Section 12 "L 	<u>egal information"</u> : updated				
BC847BPN_3	20011026	Product specification	-	BC847BPN_2		
BC847BPN_2	19990426	Preliminary specification	n -	BC847BPN_1		
BC847BPN_1	19970709	Preliminary specification	n -	-		

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12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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